TOSHIBA CCD Linear Image Sensor CCD (charge coupled device)

# TCD2561D

The TCD2561D is a high sensitive and low dark current 5340 elements  $\times 4$  line CCD color image sensor which includes CCD drive circuit, clamp circuit.

The sensor is designed for scanner. The device contains a row of 5340 elements  $\times$  4 line photodiodes which provide a 24 lines/mm across a A4 size paper. The device is operated by 5 V pulse and 12 V power supply.

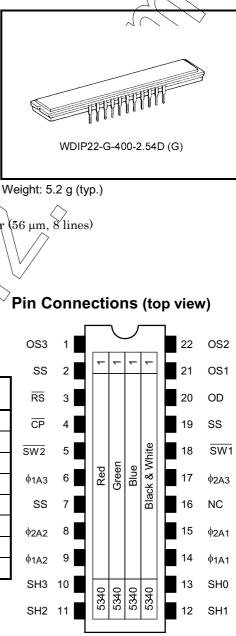
#### Features

- Number of image sensing elements: 5340 elements  $\times 4$  line
- + Image sensing element size: 7  $\mu\text{m}$   $\times$  7  $\mu\text{m}$  on 7  $\mu\text{m}$  centers
- Photo sensing region: High sensitive PN photodiode
- Distanced between photodiode array: Color (28  $\mu$ m, 4 lines), B/W-color (56  $\mu$ m, 8 lines)
- Clock: 2 phase (5 V)
- Power supply: 12 V power supply voltage
- Internal circuit: Clamp circuit
- Package: 22 Pin CERDIP package
- Color filter: Red, green, blue

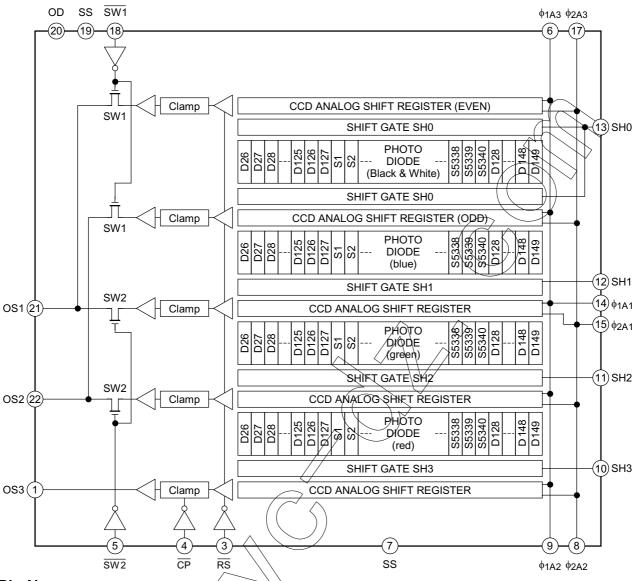
#### Maximum Ratings (Note1)

|                           |                  |            |      | _ |
|---------------------------|------------------|------------|------|---|
| Characteristic            | Symbol           | Rating     | Unit |   |
| Clock pulse voltage       | V <sub>¢</sub>   | $\square$  | V    |   |
| Shift pulse voltage       | VSH              |            | V    |   |
| Reset pulse voltage       | VRS              | -0.3~8.0   | V    |   |
| Clamp pulse voltage       | VCP              | 5)         | V    |   |
| Changeover switch voltage | Vsw              | $\swarrow$ | V    |   |
| Power supply voltage      | VOD              | -0.3~15    | V    |   |
| Operating temperature     | Topr             | 0~60       | °C   |   |
| Storage temperature       | T <sub>stg</sub> | -25~85     | °C   |   |

Note 1: All voltage are with respect to SS terminals (ground).



### **Circuit Diagram**



#### **Pin Names**

| OS3               | Signal Output 3 (red)               | OS2  | Signal Output 2 (green)             |
|-------------------|-------------------------------------|------|-------------------------------------|
| SS                | Ground                              | OS1  | Signal Output 1 (blue)              |
| RS                | Reset Gate                          | OD   | Power                               |
| CP                | Clamp Gate                          | SS   | Ground                              |
| SW2               | Changeover Switch 2 (color and B/W) | SW1  | Changeover Switch 1 (color and B/W) |
| ф1А3              | Clock 3 (phase 1)                   | ф2А3 | Clock 3 (phase 2)                   |
| SS                | Grøund                              | NC   | Non Connection                      |
| ф2А2              | Clock 2 (phase 2)                   | ф2А1 | Clock 1 (phase 2)                   |
| <sup>(</sup> 41A2 | Clock 2 (phase 1)                   | φ1A1 | Clock 1 (phase 1)                   |
| SH3               | Shift Gate 3                        | SH0  | Shift Gate 0                        |
| SH2               | Shift Gate 2                        | SH1  | Shift Gate 1                        |

#### **Optical/Electrical Characteristics**

(Ta = 25°C, V<sub>OD</sub> = 12 V, V<sub> $\phi$ </sub> = V<sub>RS</sub> = V<sub>SH</sub> = V<sub>CP</sub> = 5 V (pulse), f<sub> $\phi$ </sub> = 1.0 MHz, f<sub>RS</sub> = 1.0 MHz, LOAD RESISTANCE = 100 k $\Omega$ , t<sub>INT</sub> (INTEGRATION TIME) = 10 ms, LIGHT SOURCE = A LIGHT SOURCE + CM500S FILTER (t = 1.0 mm))

| Characteristics                   | Symbol                   | Min  | Тур. | Max  | Unit     | Note      |
|-----------------------------------|--------------------------|------|------|------|----------|-----------|
|                                   | R <sub>B/W</sub>         | 16.8 | 21.0 | 25.2 |          | $\frown$  |
| Sensitivity                       | R <sub>R</sub>           | 6.3  | 9.0  | 11.7 | V/(lx⋅s) | (Note 2)  |
| Sensitivity                       | R <sub>G</sub>           | 7.3  | 10.5 | 13.7 | V/(IX-S) |           |
|                                   | R <sub>B</sub>           | 3.8  | 5.5  | 7.2  |          |           |
| Photo response non uniformity     | PRNU (1)                 |      | 10   | 20   | (%)      | (Note 3)  |
| Photo response non uniformity     | PRNU (3)                 |      | 3    | 12   | mk       | (Note 4)  |
| Image lag                         | IL                       |      | 1    |      | ~ %<br>^ | (Note 5)  |
| Saturation output voltage (B/W)   | V <sub>SAT (B/W)</sub>   | 3.2  | 3.5  | +(   | Ý        | (Note 6)  |
| Saturation output voltage (color) | V <sub>SAT (color)</sub> | 3.2  | 3.5  | _/   | V        | (Note 6)  |
| Saturation exposure               | SE                       |      | 0.1  |      | lx·s     | (Note 7)  |
| Dark signal voltage               | V <sub>DRK</sub>         |      | 0.4  | 2.0  | mV       | (Note 8)  |
| Dark signal non uniformity        | DSNU                     | —    | ∕_7  | 12   | mV       | (Note 8)  |
| DC power dissipation              | PD                       | _//  | 480  | ~690 | mW       | —         |
| Total transfer efficiency         | TTE                      | 92   | H    | / _  | %        | _         |
| Output impedance                  | ZO                       |      | 0.3  | 1.0  | kΩ       | —         |
| DC signal output voltage          | V <sub>OS</sub>          | 5.0  | 6.0  | 7.0  | V        | (Note 9)  |
| Random noise                      | Ν <sub>Dσ</sub>          |      | 1.0  |      | mV       | (Note 10) |
| Reset noise                       | VRSN                     | _    | 0.5  | 1.0  | V        | (Note 9)  |

Note 2: Sensitivity is defined for each color of signal outputs average when the photosensitive surface is applied with the light of uniform illumination and uniform color temperature.

Note 3: PRNU (1) is defined for each color on a single chip by the expressions below when the photosensitive surface is applied with the light of uniform illumination and uniform color temperature.

$$\overrightarrow{\text{PRNU}(1)} = \frac{\Delta X}{\overline{X}} \times 100 \text{ (\%)}$$

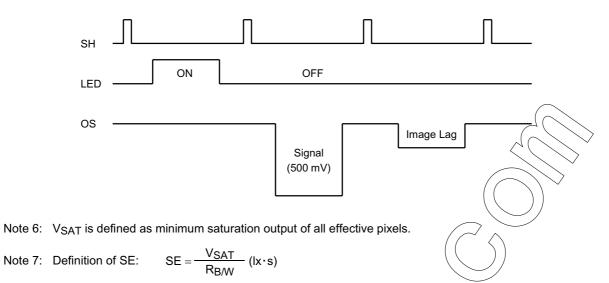
When  $\overline{X}$  is average of total signal output and  $\Delta X$  is the maximum deviation from  $\overline{X}$ . The amount of incident light is shown below.

Red 
$$=\frac{1}{2}$$
 SE, Green  $=\frac{1}{2}$  SE, Blue  $=\frac{1}{4}$  SE

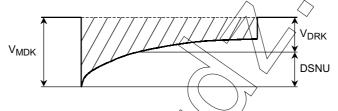
Note 4: PRNU (3) is defined as maximum voltage with next pixel, where measured 5% of SE (typ.)

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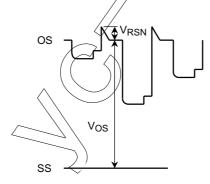
Note 5: Image Lag is defined as follows.

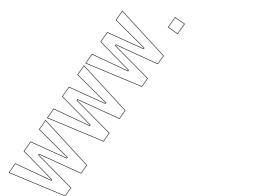


Note 8: V<sub>DRK</sub> is defined as average dark signal voltage of all effective pixels. DSNU is defined as different voltage between V<sub>DRK</sub> and V<sub>MDK</sub> when V<sub>MDK</sub> is maximum dark signal voltage.

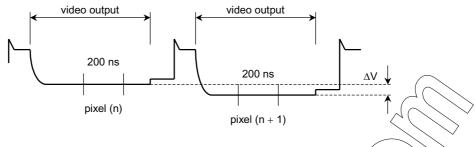


Note 9: DC signal Output Voltage and Reset Noise is defined as follows, but Reset Noise is a fixed pattern noise.





Note 10: Random noise is defined as the standard deviation (sigma) of the output level difference between two adjacent effective pixels under no illumination (i.e. dark conditions) calculated by the following procedure.



Output waveform (effective pixels under dark condition)

- (1) Two adjacent pixels (pixel n and n + 1) in one reading are fixed as measurement points.
- (2) Each of the output level at video output periods averaged over 200 ns period to get V(n) and V(n + 1).
- (3) V (n + 1) is subtracted from V (n) to get  $\Delta V$ .  $\Delta V = V (n) - V (n + 1)$
- (4) The standard deviation of  $\Delta V$  is calculated after procedure (2) and (3) are repeated 30 times (30 readings)

$$\overline{\Delta V} = \frac{1}{30} \sum_{i=1}^{30} |\Delta V_i|$$

$$\sigma = \sqrt{\frac{1}{30} \sum_{i \neq i \neq i}^{30} \Delta V_i | - \overline{\Delta V}^2}$$

- (5) Procedure (2), (3) and (4) are repeated 10 times to get sigma value.
- (6) 10 sigma values are averaged.

$$\overline{\sigma} = \frac{1}{10} \sum_{j=1}^{10} \sigma_j$$

(7)  $\overline{\sigma}$  value calculated using the above procedure is observed  $\sqrt{2}$  times larger than that measured relative to the ground level. So we specify random noise as follows.

$$N_{D\sigma} = \frac{1}{\sqrt{2}}\overline{\sigma}$$

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### **Operating Condition**

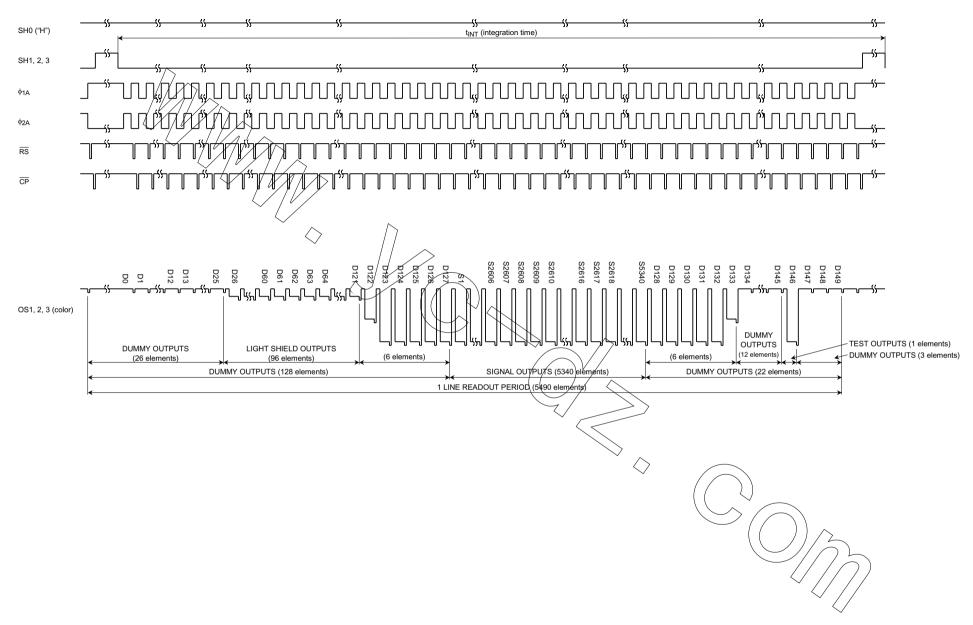
| Characteristics      | 5         | Symbol           | Min  | Тур. | Max  | Unit         | Note       |
|----------------------|-----------|------------------|------|------|------|--------------|------------|
| Clock pulse voltage  | "H" Level | V <sub>¢</sub> A | 4.5  | 5.0  | 5.5  | v            |            |
| Clock pulse voltage  | "L" Level | VφA              | 0    | —    | 0.5  | v            |            |
| Shift pulse voltage  | "H" Level | Mari             | 4.5  | 5.0  | 5.5  | v            |            |
| Shin pulse voltage   | "L" Level | V <sub>SH</sub>  | 0    | —    | 0.5  | <b>`</b> (   | $\sim$     |
| Reset pulse voltage  | "H" Level | N ===            | 4.5  | 5.0  | 5.5  | w C          | $\sum$     |
| Reset pulse voltage  | "L" Level | VRS              | 0    | —    | 0.5  |              | $\searrow$ |
| Clamp pulse voltage  | "H" Level |                  | 4.5  | 5.0  | 5.5  |              | $\searrow$ |
| Clamp pulse voltage  | "L" Level | VCP              | 0    | _    | 0.5  |              | )          |
| Switch pulse veltage | "H" Level | ., <i>(</i>      | 4.5  | 5.0  | 5.5  | $\checkmark$ | /          |
| Switch pulse voltage | "L" Level | Vsw              | 0    |      | Ø.5  | $\wedge$     |            |
| Power supply voltage |           | V <sub>OD</sub>  | 11.4 | 12.0 | 13.0 | )/v          |            |

### Clock Characteristics (Ta = 25°C)

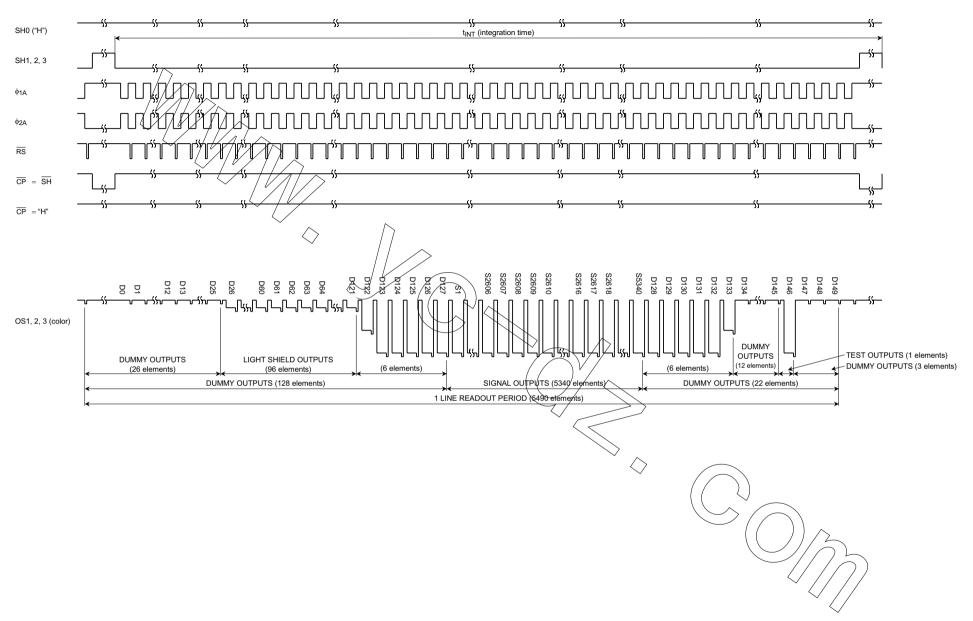
| Characteristics         |           | Symbol          | Min        | Тур.   | Max | Unit | $\langle \rangle$ |
|-------------------------|-----------|-----------------|------------|--------|-----|------|-------------------|
| Clock pulse frequency   |           | $f_{\varphi}$   | 0.3        | 1.0    | 16  | MHz  | 7                 |
| Reset pulse frequency   |           | fRS             | 0.3        | 1.0    | 10  | MHz  |                   |
| Clamp pulse frequency   |           | fCP             | 0.3        | 1.0    | 10  | MHz  |                   |
| Clock1 capacitance      | (Note 11) | C <sub>φ1</sub> | _          | 160    | 240 | рF   |                   |
| Clock2 capacitance      | (Note 11) | C <sub>¢2</sub> |            | / 1⁄30 | 195 | pF   |                   |
| Shift gate capacitance  |           | C <sub>SH</sub> | _/         | 30     | 60  | pF   |                   |
| Reset gate capacitance  |           | CRS             |            | 10     | 40  | pF   |                   |
| Clamp gate capacitance  |           | CCP             | $ \langle$ | 10     | 40  | pF   |                   |
| Switch gate capacitance |           | Csw             |            | / 10   | 40  | pF   |                   |

Note 11: V<sub>OD</sub> = 12 V

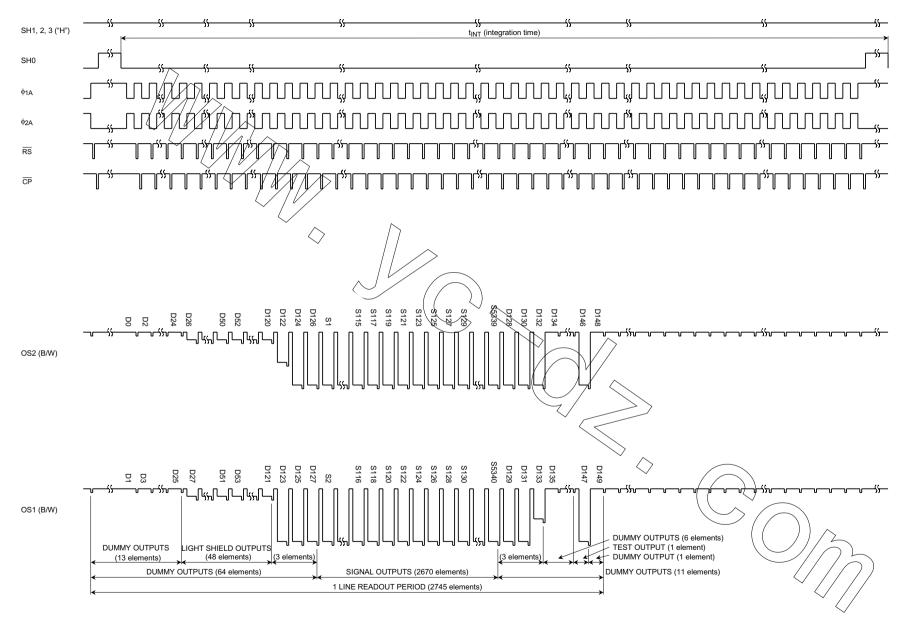
#### Timing Chart 1: Bit Clamp Mode (Color mode)



Timing Chart 2: Line Clamp Mode (Color mode)

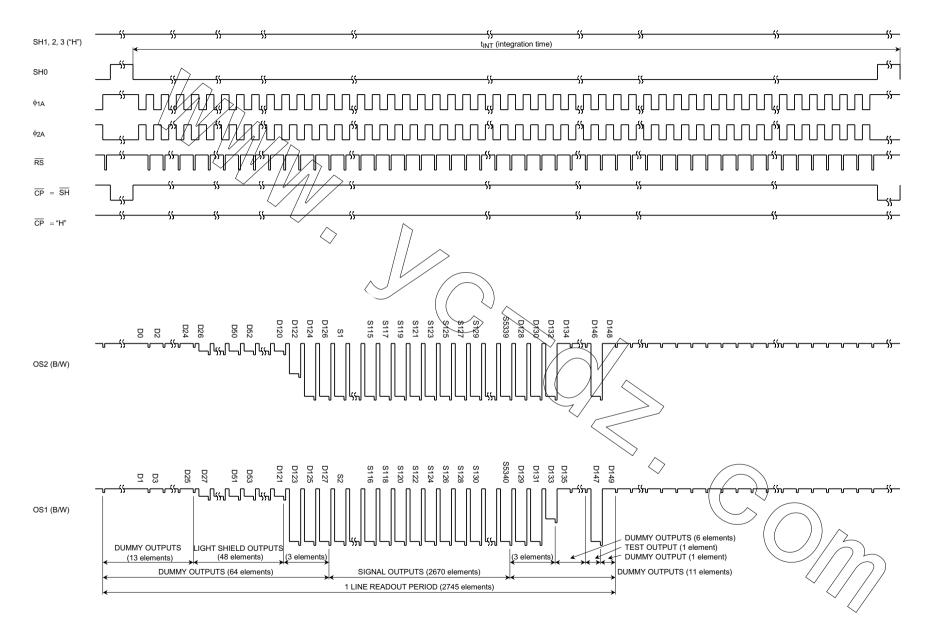


#### Timing Chart 3: Bit Clamp Mode (B/W mode)

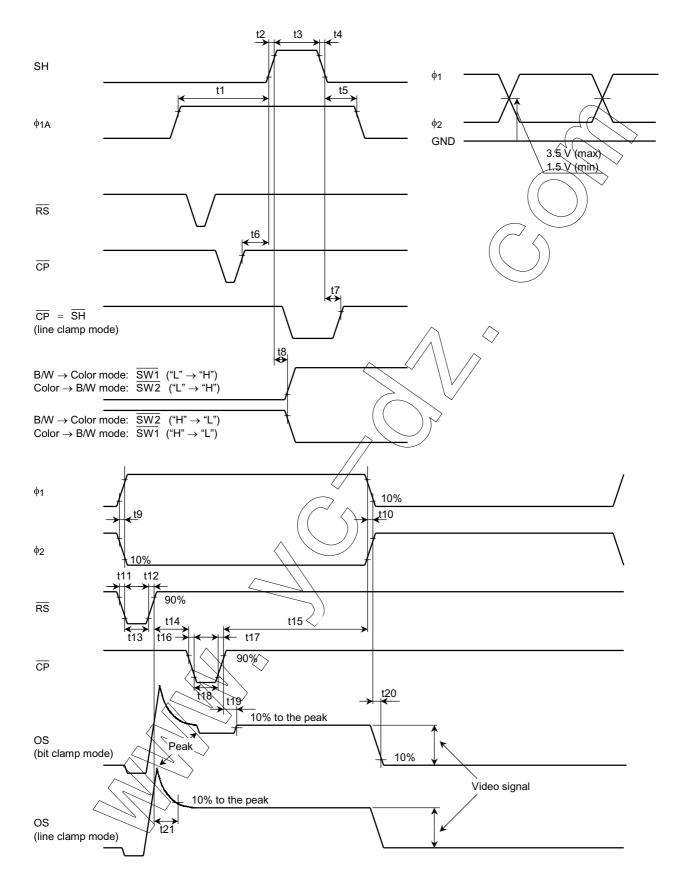


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Timing Chart 4: Line Clamp Mode (B/W mode)



#### **Timing Requirements**



#### **Timing Requirements (cont.)**

| Characteristics   | Symbol   | Min       | Typ.<br>(Note 12) | Max           | Unit      |               |
|---|----------|-----------|-------------------|---------------|-----------|---------------|
| Pulse timing of SH and ∳1   | t1       | 120       | 1000              | _             | 20        |               |
| Pulse unning of SH and \$1  | t5       | 800       | 1000              |               | ns        |               |
| SH pulse rise time, fall time                                     | t2, t4   | 0         | 50                | _             | ns        |               |
| SH pulse width  | t3       | 3000      | 5000              | _             | ns        |               |
| Pulse timing of SH and $\overline{CP}$                            | t6       | 200       | 500               | _             | ns        |               |
| Pulse timing of SH and CP<br>(line clamp mode)                    | t7       | 10        | 100               | _             | ns        |               |
| Pulse timing of SH and SW   | t8       | 100       | 500               | t3 – 100      | ns        |               |
| $\phi$ 1, $\phi$ 2 pulse rise time, fall time                     | t9, t10  | 0         | 50                | _             | ns        | $\mathcal{I}$ |
| RS pulse rise time, fall time                                     | t11, t12 | 0         | 20                | - (           | $\Box$ ns |               |
| RS pulse width  | t13      | 10 (20)   | 80                | — ( (         | ns)       |               |
| Pulse timing of $\overline{\text{RS}}$ and $\overline{\text{CP}}$ | t14      | 0         | 40                | - \           | ns        |               |
| Pulse timing of $\phi_{1A}$ , $\phi_{2A}$ and $\overline{CP}$     | t15      | 0         | 20                | _             | ns        |               |
| CP pulse rise time, fall time                                     | t16, t17 | 0         | 20                | _             | ns        |               |
| CP   pulse width   (Note 13)                                      | t18      | 30 (3000) | 80 (5000)         | $\rightarrow$ | ns        |               |
| Reference level settle time<br>(bit clamp mode)                   | t19      | - <       | 20                | 40 (Note 16)  | ns        |               |
| Video data delay time (Note 14)                                   | t20      | —         | 20                | 40 (Note 15)  | ns        |               |
| Reference level settle time<br>(line clamp mode)                  | t21      | (         | 30                | 50 (Note 16)  | ns        |               |

Note 12: Typ. is the case of  $f_{RS} = 1.0$  MHz.

Note 13: Line clamp Mode inside ( ).

Note 14: Load Resistance is 100 k $\Omega$ .

Note 15: Typical settle time to about 1% of fina value.

Note 16: Typical settle time to about 1% of the peak

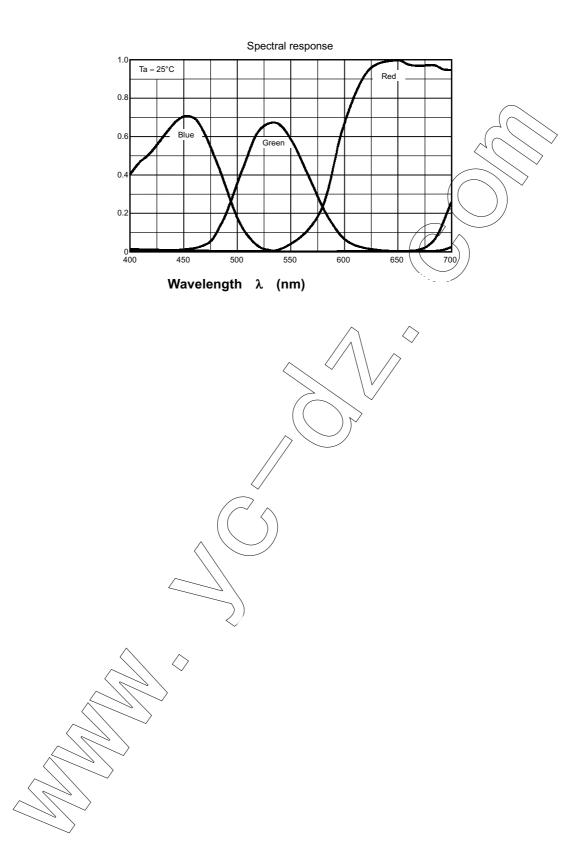
#### Clamp Mode

| Clamp Means | CP Input Pulse |            |
|-------------|----------------|------------|
| Bit Clamp   | CP Pulse       |            |
| Line Clamp  | "H" or SH      | $\searrow$ |

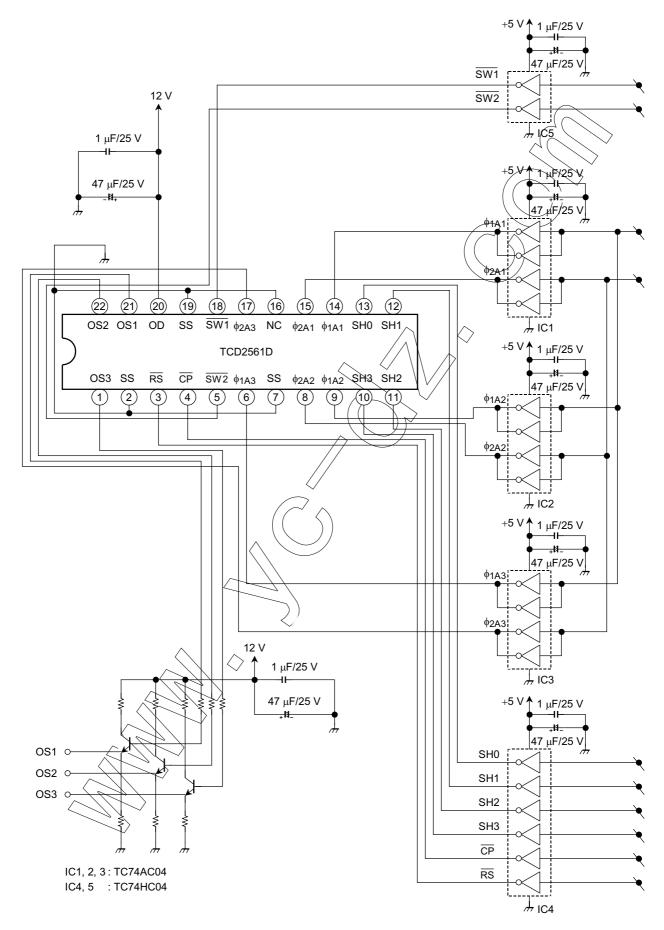
### Changeover Switch Mode

| Output Type | SW1 Input Pulse | SW2 Input Pulse | SH Input Pulse                     |
|-------------|-----------------|-----------------|------------------------------------|
| Color       | "H"             | "L"             | SH1, 2, 3 = SH Pulse,<br>SH0 = "H" |
| B/W         | "L"             | "H"             | SH0 = SH Pulse,<br>SH1, 2, 3 = "H" |

### **Typical Spectral Response**



### **Typical Drive Circuit**



#### Caution

Window Glass

The dust and stain on the glass window of the package degrade optical performance of CCD sensor. Keep the glass window clean by saturating a cotton swab in alcohol and lightly wiping the surface, and allow the glass to dry, by blowing with filtered dry N2. Care should be taken to avoid mechanical or thermal shock because the glass window is easily to damage.

#### 1. Electrostatic Breakdown

Store in shorting clip or in conductive foam to avoid electrostatic breakdown.

CCD Image Sensor is protected against static electricity, but interior puncture mode device due to static electricity is sometimes detected. In handing the device, it is necessary to execute the following static electricity preventive measures, in order to prevent the trouble rate increase of the manufacturing system due to static electricity.

- a. Prevent the generation of static electricity due to friction by making the work with bare hands or by putting on cotton gloves and non-charging working clothes.
- b. Discharge the static electricity by providing earth plate or earth wire on the floor, door or stand of the work room.
- c. Ground the tools such as soldering iron, radio cutting pliers of or pincer.
  It is not necessarily required to execute all precaution items for static electricity.
  It is all right to mitigate the precautions by confirming that the trouble rate within the prescribed range.

#### 2. Incident Light

CCD sensor is sensitive to infrared light. Note that infrared light component degrades resolution and PRNU of CCD sensor.

#### 3. Lead Frame Forming

Since this package is not strong against mechanical stress, you should not reform the lead frame. We recommend to use a IC-inserter when you assemble to PCB.

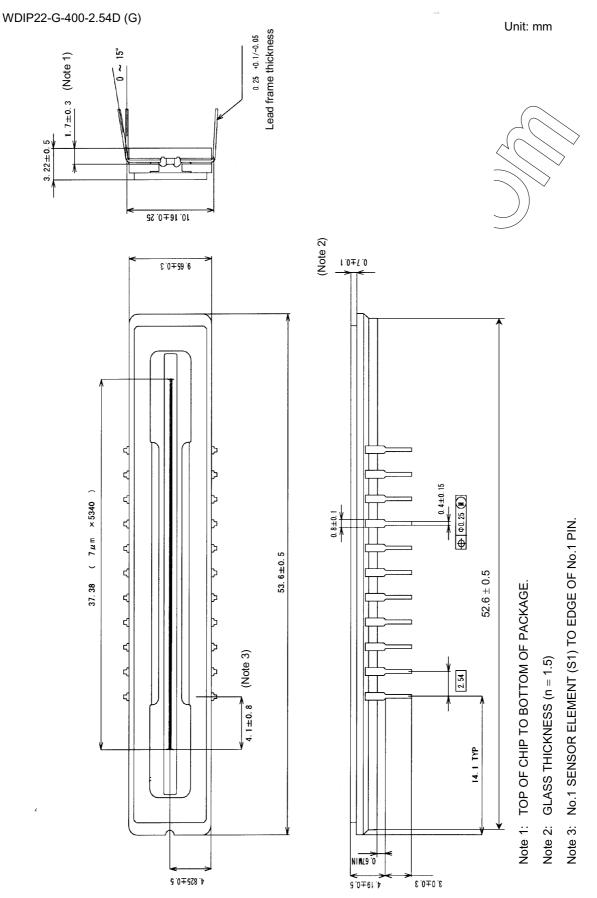
#### 4. Soldering

Soldering by the solder flow method cannot be guaranteed because this method may have deleterious effects on prevention of window glass soiling and heat resistance.

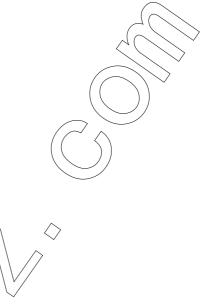
Using a soldering iron, complete soldering within ten seconds for lead temperatures of up to 260°C, or within three seconds for lead temperatures of up to 350°C.

### TCD2561D

### Package Dimensions



Weight: 5.2 g (typ.)



#### **RESTRICTIONS ON PRODUCT USE**

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